

STTH4R06DEE

Turbo 2 ultrafast recovery diode

Datasheet – production data

Features

- Very low switching losses
- High frequency and high pulse current operation
- Low thermal resistance
- High junction temperature
- ECOPACK[®]2 compliant component

Description

The STTH4R06 series uses ST's new 600 V planar Pt doping technology. The STTH4R06 is specially suited for switching mode base drive and transistor circuits.

Packaged in PowerFLAT[™], this device is intended for use in low profile applications.

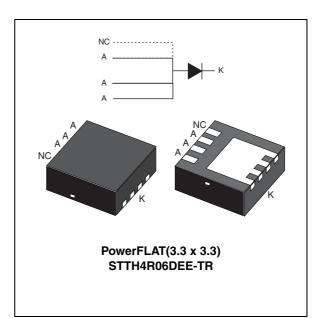


Table 1. Device summary

Symbol	Value
I _{F(AV)}	4 A
V _{RRM}	600 V
T _j (max)	150 °C
V _F (typ)	1.0 V
T _{RR} (typ)	30 ns

TM: PowerFLAT is a trademark of STMicroelectronics

Doc ID 023262 Rev 1

1 Characteristics

Table 2.Absolute ratings (limiting values $T_{amb} = 25$ °C unless otherwise specified)

Symbol	Parameter	Value	Unit	
V _{RRM}	Repetitive peak reverse voltage	600	V	
I _{F(RMS)}	Forward rms current		15	А
I _{F(AV)}	Average forward current	4	А	
I _{FSM}	Surge non repetitive forward current	60	А	
T _{stg}	Storage temperature range	-65 to +150	°C	
Tj	Maximum operating junction tempera	150	°C	

Table 3. Thermal resistance

Symbol	Parameter	Value	Unit
R _{th(j-c)}	Junction to case	4.5	°C/W
R _{th(j-a)}	Junction to ambient on printed circuit board (with recommended footprint, copper thickness = $35 \ \mu m$)	250	°C/W

Table 4. Static electrical characteristics

Symbol	Parameter	Test conditions		Min.	Тур.	Max.	Unit
I _B ⁽¹⁾	Reverse leakage	T _j = 25 °C	V _R = V _{RRM}	-		3	μA
'R'	current	T _j = 125 °C	VR − VRRM	-	3	30	μA
V _F ⁽²⁾	Forward voltage drop	T _j = 25 °C	$I_F = 4A$		1.30	1.70	V
VF. /	Torward voltage drop	T _j = 150 °C		-	1.0	1.25	v

1. Pulse test: $t_p = 5 \text{ ms}, \delta < 2\%$

2. Pulse test: $t_p = 380 \ \mu s, \ \delta < 2\%$

To evaluate the conduction losses use the following equation:

 $P = 1 \times I_{F(AV)} + 0.062 \times I_{F}^{2}(RMS)$

Table 5.Dynamic electrical characteristics

Symbol	Parameter	Test conditions			Тур.	Max.	Unit
I _{RM}	Reverse recovery current	T _i = 125 °C	I _F = 4 A, V _R = 400 V, dl _F /dt = -200 A/μs		5.5	7.5	А
S _{factor}	Softness factor	,	$dI_{F}/dt = -200 \text{ A}/\mu \text{s}$		2		
+	Reverse recovery time	T _i = 25 °C	I _F = 1A, V _R = 30 V, dI _F /dt = -50 A/μs		35	50	ns
t _{rr}	neverse recovery time	$T_{j} = 25 \ C$	I _F = 1A, V _R = 30 V, dI _F /dt = -100 A/μs		30	40	115
t _{fr}	Forward recovery time	$T_j = 25 \text{ °C}$ I _F = 4 A, V _{FB} = 2 V				100	ns
V _{FP}	Forward recovery voltage		$dl_{\rm F}/dt = 100 \text{ A}/\mu \text{s}$		3.5	5	V

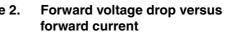


VFM(V)

3.5

3.0

Figure 1. Average forward power dissipation Figure 2. versus average forward current



T_j=25 °C (Maximum valu

2.5

Tj=150 °C (Typical values)

| | T_j=150 °C

> / ;;

> > 1.0

0.5

(Maximum va

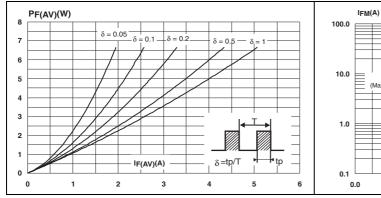


Figure 3. Relative variation of thermal impedance junction to case versus pulse duration

Figure 4. Peak reverse recovery current versus dl_F/dt (typical values)

1.5

2.0

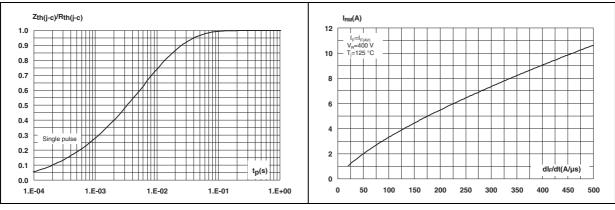
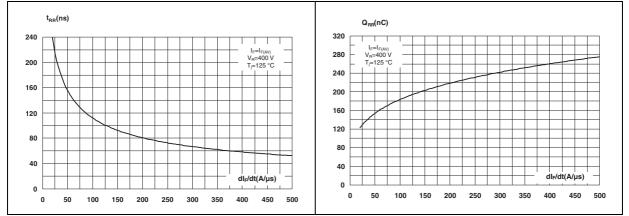


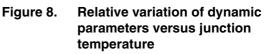
Figure 5. Reverse recovery time versus dl_F/dt Figure 6. (typical values)

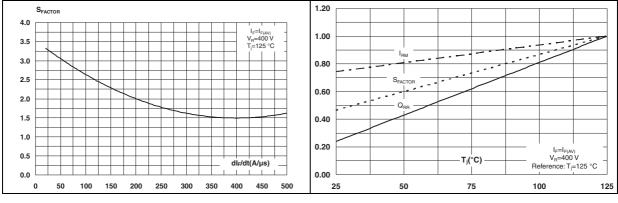
Reverse recovery charges versus dl_F/dt (typical values)



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Figure 7. Reverse recovery softness factor versus dl_F/dt (typical values)





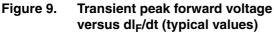


Figure 10. Forward recovery time versus dl_F/dt (typical values)

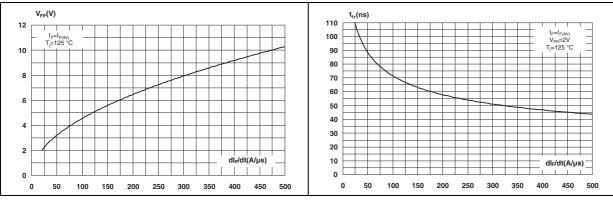
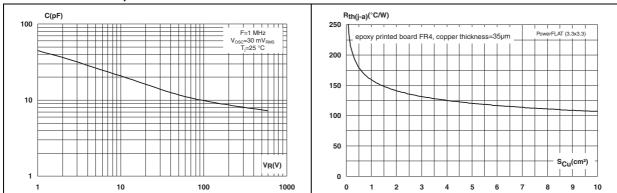


Figure 11. Junction capacitance versus reverse voltage applied (typical values)

Figure 12. Thermal resistance junction to ambient versus copper surface under tab





2 Package information

- Epoxy meets UL94,V0
- Lead-free package

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: *www.st.com.* ECOPACK[®] is an ST trademark.

Figure 13. PowerFLAT (3.3 x 3.3) dimensions (definitions)

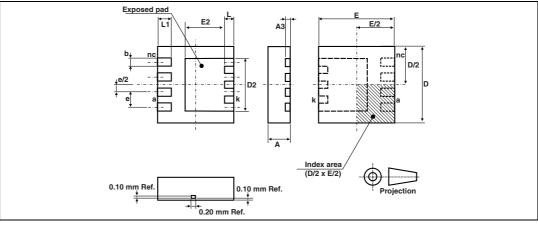
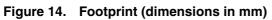
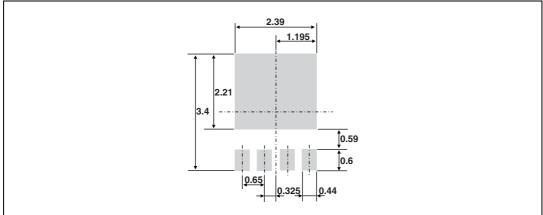


Table 6. PowerFLAT (3.3 x 3.3) dimensions (values)

	Dimensions						
Ref.	Millimeters			Inches			
	Min.	Тур.	Max.	Min.	Тур.	Max.	
A	0.95		1.0	0.037		0.039	
A3		0.2			0.008		
b	0.29	0.34	0.39	0.011	0.013	0.015	
D	3.20	3.30	3.40	0.126	0.130	0.134	
D2	2.24	2.29	2.34	0.088	0.090	0.092	
E	3.20	3.30	3.40	0.126	0.130	0.134	
E2	1.66	1.71	1.76	0.065	0.067	0.069	
е		0.65			0.026		
L		0.40			0.016		
L1	0.45	0.50	0.55	0.018	0.20	0.22	







3 Ordering information

Table 7.Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode
STTH4R06DEE-TR	TH4R06	PowerFLAT (3.3 x 3.3)	34 mg	3000	Tape and reel 13" reel

4 Revision history

Table 8.Document revision history

Date	Revision	Changes
11-Sep-2012	1	First issue.



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